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November 1988 Revised March 2005

#### 74AC540

### Octal Buffer/Line Driver with 3-STATE Outputs

#### **General Description**

The AC540 is an octal buffer/line drivers designed to be employed as memory and address drivers, clock drivers and bus oriented transmitter/receivers.

These devices are similar in function to the AC240 while providing flow-through architecture (inputs on opposite side from outputs). This pinout arrangement makes these devices especially useful as output ports for microprocessors, allowing ease of layout and greater PC board density.

#### **Features**

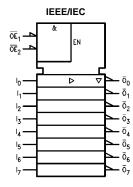
- I<sub>CC</sub> and I<sub>OZ</sub> reduced by 50%
- 3-STATE inverting outputs
- Inputs and outputs opposite side of package, allowing easier interface to microprocessors
- Output source/sink 24 mA

#### **Ordering Code:**

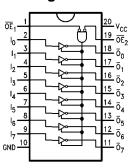
Order Number	Package Number	Package Description
74AC540SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74AC540SJ	M20D	Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74AC540MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74AC540PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

#### **Logic Symbol**



#### **Connection Diagram**



#### **Truth Table**

	Outputs		
OE <sub>1</sub>	OE <sub>2</sub>	1	
L	L	Н	L
Н	Χ	Χ	Z
Х	Н	X	Z
L	L	L	Н

H = HIGH Voltage Level L = LOW Voltage Level

X = Immaterial Z = High Impedance

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#### Absolute Maximum Ratings(Note 1)

-0.5V to +7.0V Supply Voltage (V<sub>CC</sub>) DC Input Diode Current (I<sub>IK</sub>)

 $V_I = -0.5V$ -20 mA  $V_I = V_{CC} + 0.5V$ +20 mA DC Input Voltage (V<sub>I</sub>) -0.5V to  $V_{CC}$  + 0.5V

DC Output Diode Current (I<sub>OK</sub>)

 $V_0 = -0.5V$ -20 mA  $V_O = V_{CC} + 0.5V$ +20 mA -0.5V to  $V_{CC} + 0.5V$ 

DC Output Voltage (V<sub>O</sub>)

DC Output Source

or Sink Current (I<sub>O</sub>) ±50 mA

DC V<sub>CC</sub> or Ground Current

per Output Pin ( $I_{CC}$  or  $I_{GND}$ ) ±50 mA

-65°C to +150°C Storage Temperature (T<sub>STG</sub>)

Junction Temperature (T<sub>J</sub>)

PDIP 140°C

#### **Recommended Operating Conditions**

Supply Voltage (V<sub>CC</sub>) 2.0V to 6.0V 0V to V<sub>CC</sub> Input Voltage (V<sub>I</sub>) 0V to  $V_{\mbox{\footnotesize CC}}$ Output Voltage (V<sub>O</sub>) Operating Temperature (T<sub>A</sub>) -40°C to +85°C Minimum Input Edge Rate ( $\Delta V/\Delta t$ ) 125 mV/ns

 $V_{\mbox{\scriptsize IN}}$  from 30% to 70% of  $V_{\mbox{\scriptsize CC}}$ V<sub>CC</sub> @ 3.3V, 4.5V, 5.5V

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications.

#### **DC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40° C to +85°C	Units	Conditions
Symbol		(V)	Тур	Guaranteed Limits		Ollits	
V <sub>IH</sub>	Minimum HIGH Level	3.0	1.5	2.1	2.1		V <sub>OUT</sub> = 0.1V
	Input Voltage	4.5	2.25	3.15	3.15	V	or V <sub>CC</sub> = 0.1V
		5.5	2.75	3.85	3.85		
V <sub>IL</sub>	Maximum LOW Level	3.0	1.5	0.9	0.9		V <sub>OUT</sub> = 0.1V
	Input Voltage	4.5	2.25	1.35	1.35	V	or V <sub>CC</sub> = 0.1V
		5.5	2.75	1.65	1.65		
V <sub>OH</sub>	Minimum HIGH Level	3.0	2.99	2.9	2.9		
	Output Voltage	4.5	4.49	4.4	4.4	V	$I_{OUT} = -50 \mu A$
		5.5	5.49	5.4	5.4		
							$V_{IN} = V_{IL}$ or $V_{IH}$
		3.0		2.56	2.46		$I_{OH} = -12 \text{ mA}$
		4.5		3.86	3.76	V	$I_{OH} = -24 \text{ mA}$
		5.5		4.86	4.76		I <sub>OH</sub> = -24 mA (Note 2)
V <sub>OL</sub>	Maximum LOW Level	3.0	0.002	0.1	0.1		
	Output Voltage	4.5	0.001	0.1	0.1	V	$I_{OUT} = 50 \mu A$
		5.5	0.001	0.1	0.1		
							$V_{IN} = V_{IL}$ or $V_{IH}$
		3.0		0.36	0.44		$I_{OL} = 12 \text{ mA}$
		4.5		0.36	0.44	V	$I_{OL} = 24 \text{ mA}$
		5.5		0.36	0.44		I <sub>OL</sub> = 24 mA (Note 2)
I <sub>IN</sub>	Maximum Input	5.5		±0.1	±1.0	μА	$V_I = V_{CC}$ , GND
(Note 4)	Leakage Current						
I <sub>OZ</sub>	Maximum 3-STATE						$V_{I}$ (OE) = $V_{IL}$ , $V_{IH}$
	Current	5.5		±0.25	±2.5	μΑ	$V_I = V_{CC}$ , GND
							$V_O = V_{CC}$ , GND
I <sub>OLD</sub>	Minimum Dynamic	5.5			75	mA	V <sub>OLD</sub> = 1.65V Max
I <sub>OHD</sub>	Output Current (Note 3)	5.5			-75	mA	V <sub>OHD</sub> = 3.85V Min
I <sub>CC</sub>	Maximum Quiescent	5.5		4.0	40.0	μА	$V_{IN} = V_{CC}$
(Note 4)	Supply Current						or GND

Note 2: All outputs loaded; thresholds on input associated with output under test.

Note 3: Maximum test duration 2.0 ms, one output loaded at a time.

Note 4:  $I_{IN}$  and  $I_{CC}$  @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V  $V_{CC}$ .

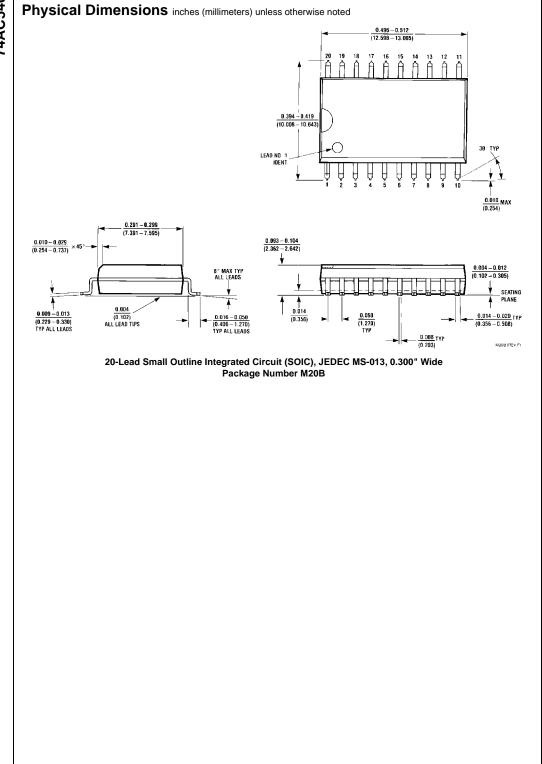
## **AC Electrical Characteristics**

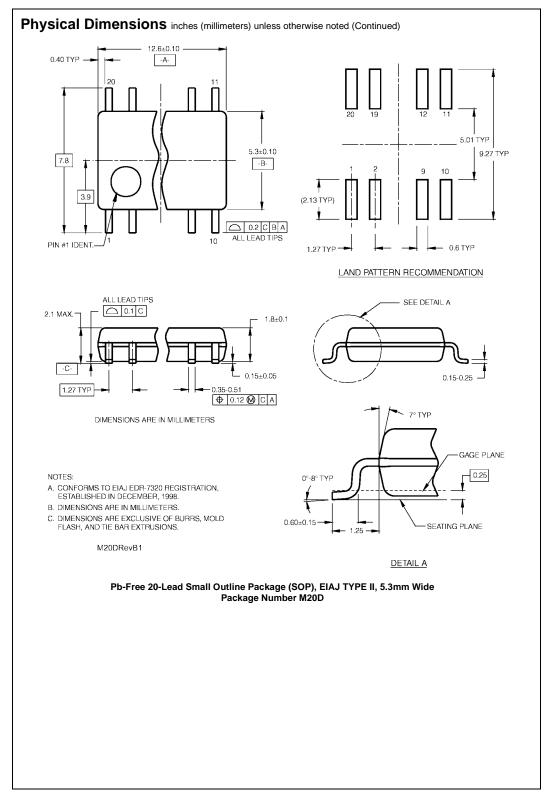
	Parameter	V <sub>CC</sub>	$T_A = +25^\circC$ $C_L = 50\;pF$			$T_A = -40$ °C to $+85$ °C $C_L = 50$ pF		Units
Symbol		(V)						
		(Note 5)	Min	Тур	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	3.3	1.5	5.5	7.5	1.0	8.0	ns
	Data to Output	5.0	1.5	4.0	6.0	1.0	6.5	ns
t <sub>PHL</sub>	Propagation Delay	3.3	1.5	5.0	7.0	1.0	7.5	ns
	Data to Output	5.0	1.5	4.0	5.5	1.0	6.0	
t <sub>PZH</sub>	Output Enable Time	3.3	3.0	8.5	11.0	2.5	12.0	ns
		5.0	2.0	6.5	8.5	2.0	9.5	
t <sub>PZL</sub>	Output Enable Time	3.3	2.5	7.5	10.0	2.0	11.0	20
		5.0	2.0	6.0	7.5	1.5	8.5	ns
t <sub>PHZ</sub>	Output Disable Time	3.3	2.5	8.5	13.0	1.5	14.0	ns
		5.0	1.5	7.5	10.5	1.0	11.0	ns
t <sub>PLZ</sub>	Output Disable Time	3.3	2.5	7.0	10.0	2.0	11.0	20
		5.0	1.5	6.0	8.0	1.5	9.0	ns

Note 5: Voltage Range 3.3 is 3.3V ± 0.3V Voltage Range 5.0 is 5.0V ± 0.5V

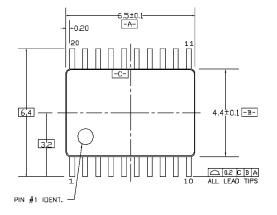
### Capacitance

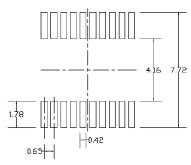
Symbol	Parameter	Тур	Units	Conditions
C <sub>IN</sub>	Input Capacitance	4.5	pF	V <sub>CC</sub> = OPEN
C <sub>PD</sub>	Power Dissipation Capacitance	30.0	pF	V <sub>CC</sub> = 5.0V



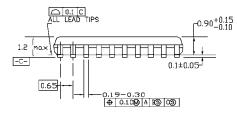


#### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





LAND PATTERN RECOMMENDATION



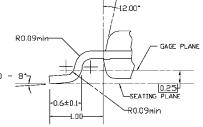


SEE DETAIL A

DIMENSIONS ARE IN MILLIMETERS

#### NOTES:

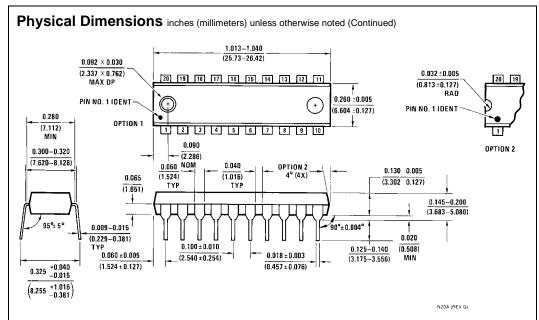
- A. CONFORMS TO JEDEC REGISTRATION MID-153, VARIATION AC, REF NOTE 6. DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND THE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.



DETAIL A

#### MTC20REVD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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